

| SPECIFICATIONS (T _J = 25 °C, unless otherwise noted) | | | | | | |
|---|--------------------------------------|--|-------|-------|-------|-------|
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = - 250 μA | - 12 | | | V |
| V _{DS} Temperature Coefficient | ΔV _{DS} /T _J | I _D = - 250 μA | | - 11 | | mV/°C |
| V _{GS(th)} Temperature Coefficient | ΔV _{GS(th)} /T _J | | | 2.7 | | |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = - 250 μA | - 0.4 | | - 1 | V |
| Gate-Source Leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = ± 8 V | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = - 12 V, V _{GS} = 0 V | | | - 1 | μA |
| | | V _{DS} = - 12 V, V _{GS} = 0 V, T _J = 55 °C | | | - 10 | |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} ≤ - 5 V, V _{GS} = - 4.5 V | - 20 | | | A |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 4.5 V, I _D = - 6.7 A | | 0.024 | 0.029 | Ω |
| | | V _{GS} = - 2.5 V, I _D = - 6.2 A | | 0.028 | 0.034 | |
| | | V _{GS} = - 1.8 V, I _D = - 2.3 A | | 0.036 | 0.044 | |
| | | V _{GS} = - 1.5 V, I _D = - 1 A | | 0.050 | 0.100 | |
| Forward Transconductance ^a | g _{fs} | V _{DS} = - 10 V, I _D = - 6.7 A | | 30 | | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz | | 1800 | | pF |
| Output Capacitance | C _{oss} | | | 450 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 390 | | |
| Total Gate Charge | Q _g | V _{DS} = - 6 V, V _{GS} = - 8 V, I _D = - 10 A | | 38 | 57 | nC |
| | | V _{DS} = - 6 V, V _{GS} = - 4.5 V, I _D = - 10 A | | 23 | 35 | |
| Gate-Source Charge | Q _{gs} | | | 3 | | |
| Gate-Drain Charge | Q _{gd} | | | 6.5 | | |
| Gate Resistance | R _g | f = 1 MHz | | 7 | | Ω |
| Turn-On Delay Time | t _{d(on)} | V _{DD} = - 6 V, R _L = 0.75 Ω I _D ≅ - 8 A, V _{GEN} = - 4.5 V, R _g = 1 Ω | | 20 | 30 | ns |
| Rise Time | t _r | | | 40 | 60 | |
| Turn-Off Delay Time | t _{d(off)} | | | 65 | 100 | |
| Fall Time | t _f | | | 40 | 60 | |
| Turn-On Delay Time | t _{d(on)} | V _{DD} = - 6 V, R _L = 0.75 Ω I _D ≅ - 8 A, V _{GEN} = - 8 V, R _g = 1 Ω | | 10 | 15 | |
| Rise Time | t _r | | | 12 | 20 | |
| Turn-Off Delay Time | t _{d(off)} | | | 70 | 105 | |
| Fall Time | t _f | | | 40 | 60 | |
| Drain-Source Body Diode Characteristics | | | | | | |
| Continuous Source-Drain Diode Current | I _S | T _C = 25 °C | | | - 12 | A |
| Pulse Diode Forward Current | I _{SM} | | | | 40 | |
| Body Diode Voltage | V _{SD} | I _S = - 8 A, V _{GS} = 0 V | | - 0.8 | - 1.2 | V |
| Body Diode Reverse Recovery Time | t _{rr} | I _F = - 8 A, di/dt = 100 A/μs, T _J = 25 °C | | 40 | 60 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | 20 | 30 | nC |
| Reverse Recovery Fall Time | t _a | | | 14 | | ns |
| Reverse Recovery Rise Time | t _b | | | 26 | | |

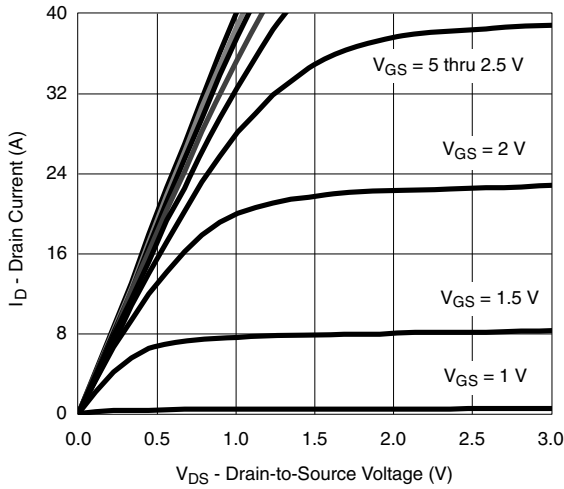
Notes:

a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

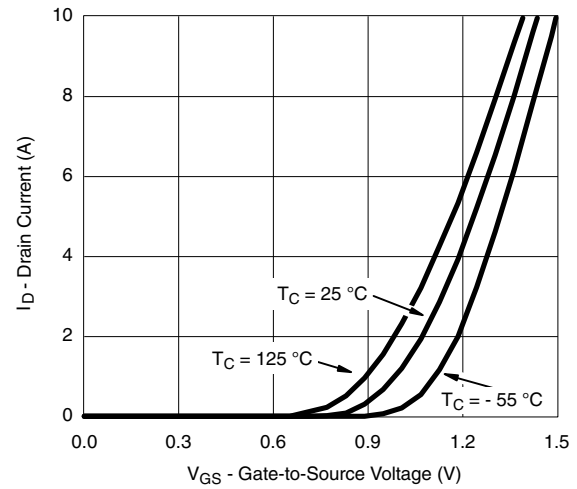
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

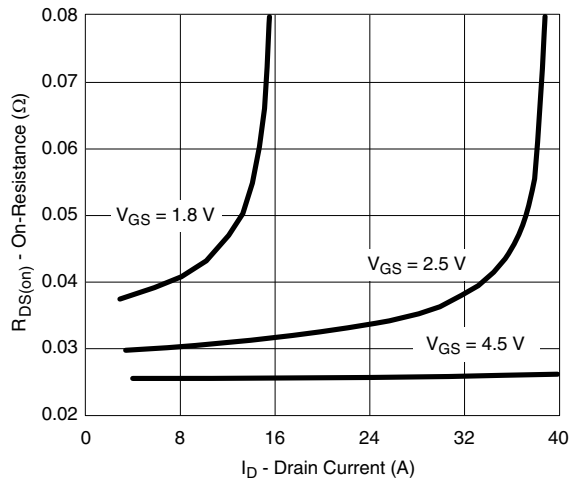
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



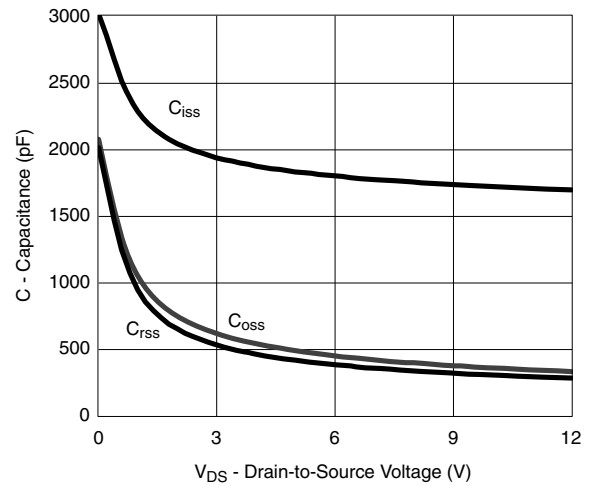
Output Characteristics



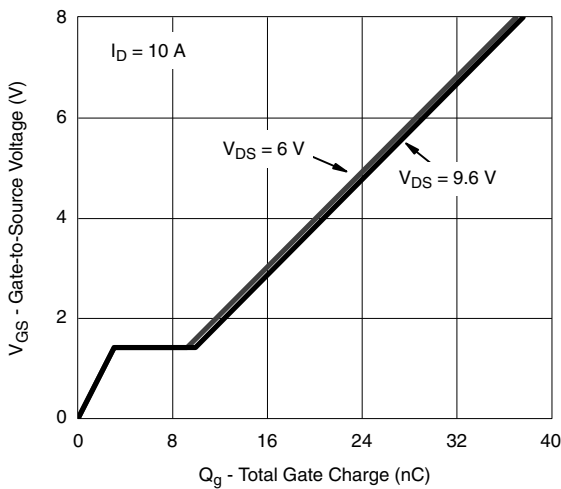
Transfer Characteristics



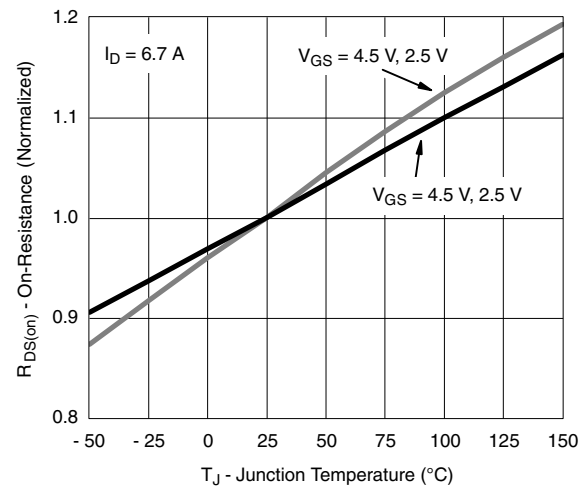
On-Resistance vs. Drain Current and Gate Voltage



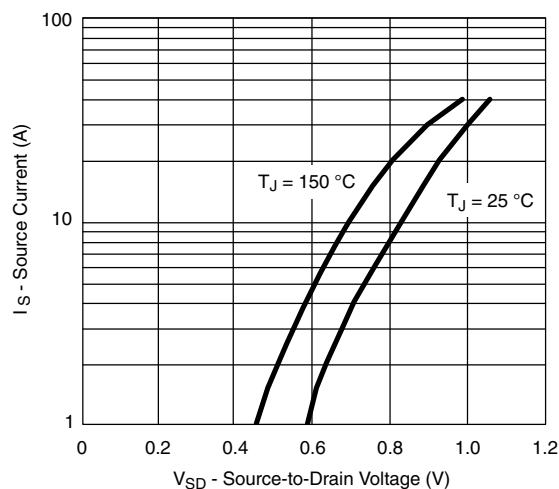
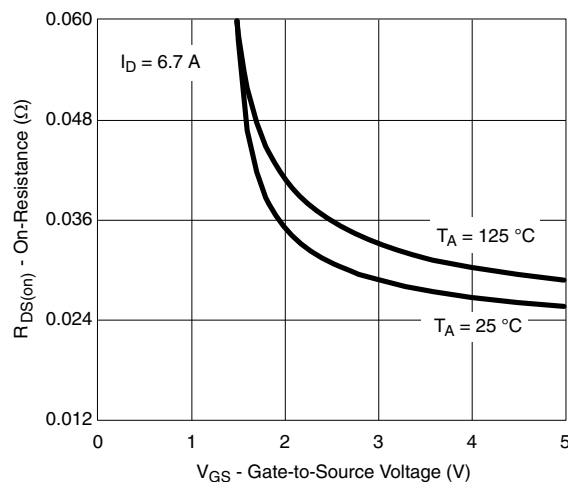
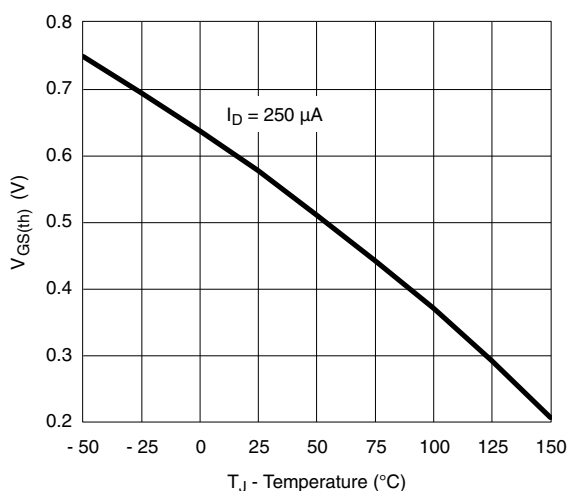
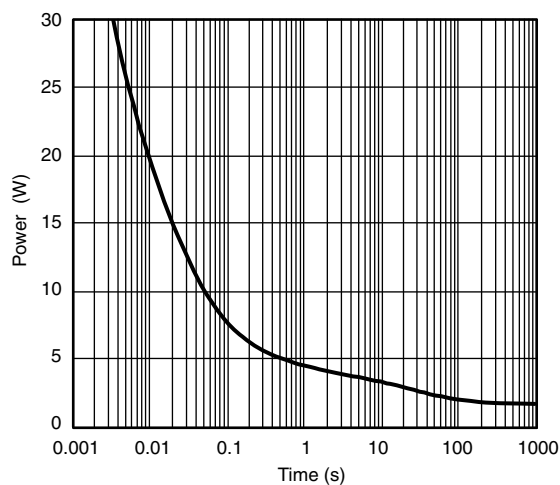
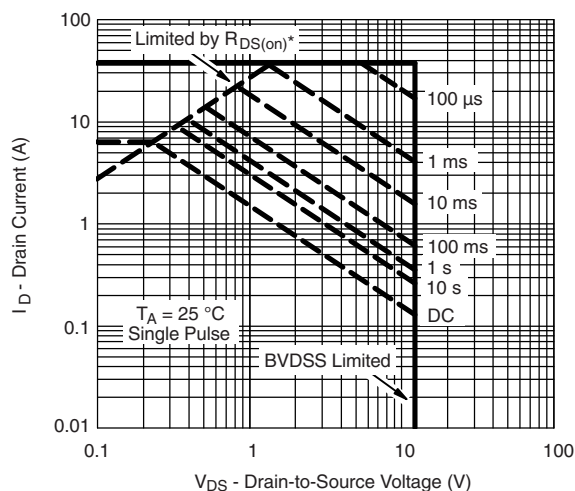
Capacitance



Gate Charge

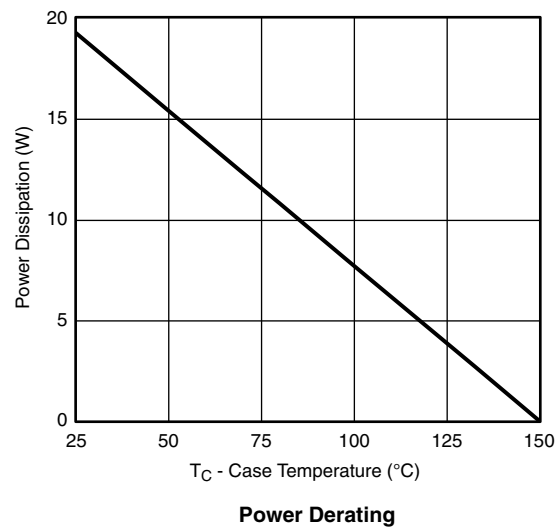
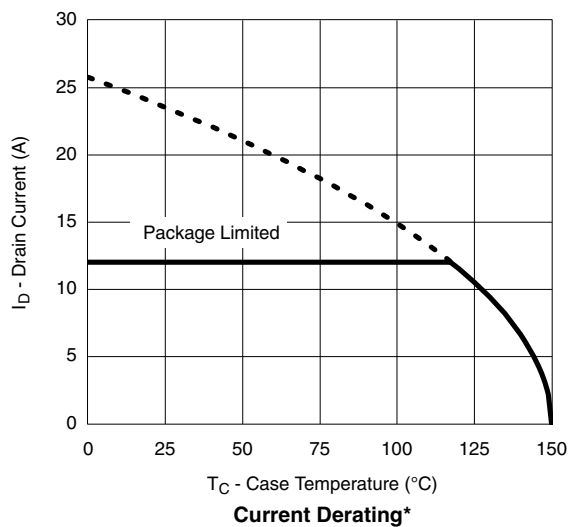


On-Resistance vs. Junction Temperature

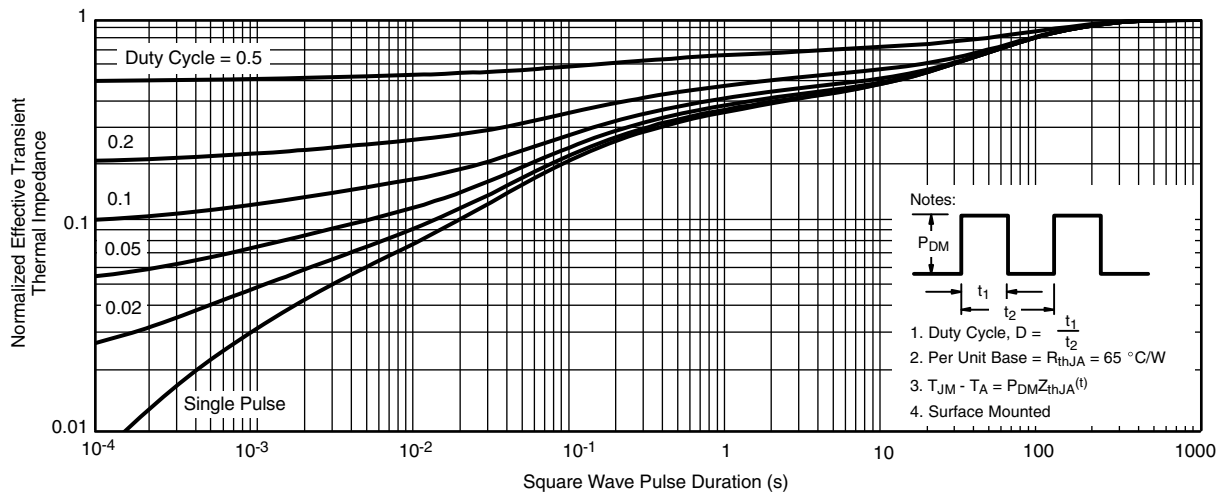
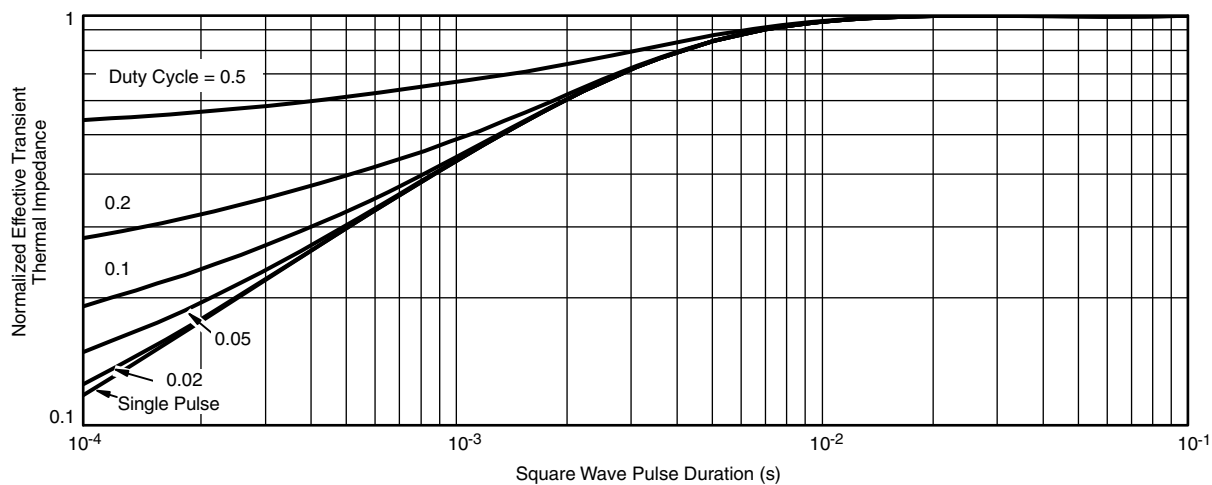
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)**Source-Drain Diode Forward Voltage****On-Resistance vs. Gate-to-Source Voltage****Threshold Voltage****Single Pulse Power, Junction-to-Ambient**

* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified
Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



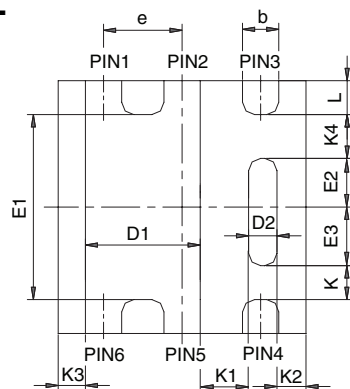
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)**Normalized Thermal Transient Impedance, Junction-to-Ambient****Normalized Thermal Transient Impedance, Junction-to-Case**

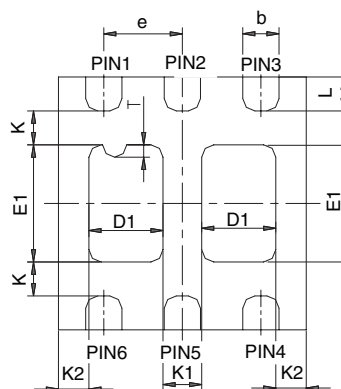
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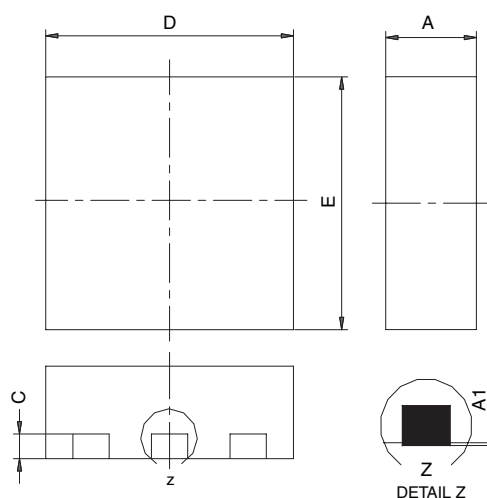
PowerPAK® SC70-6L



BACKSIDE VIEW OF SINGLE



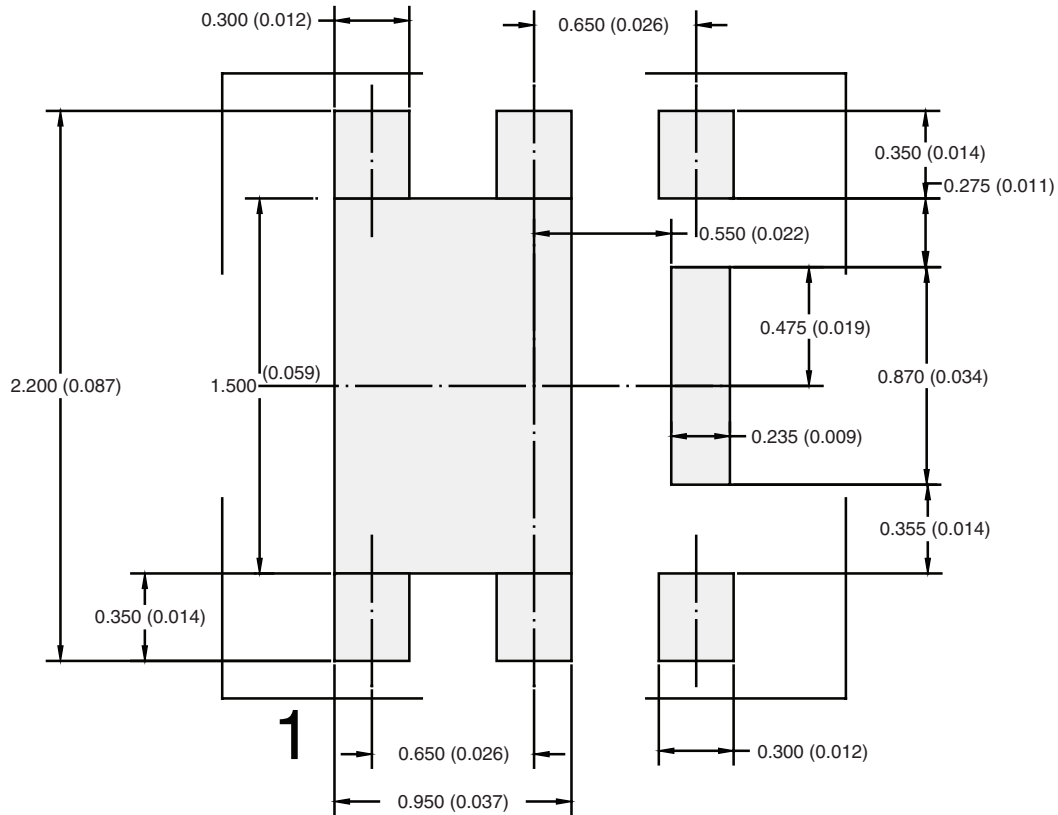
BACKSIDE VIEW OF DUAL



- Notes:
1. All dimensions are in millimeters
 2. Package outline exclusive of mold flash and metal burr
 3. Package outline inclusive of plating

| DIM | SINGLE PAD | | | | | | DUAL PAD | | | | | |
|----------------------------------|-------------|-------|-------|-----------|-------|-------|-------------|-------|-------|-----------|-------|-------|
| | MILLIMETERS | | | INCHES | | | MILLIMETERS | | | INCHES | | |
| | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max | Min | Nom | Max |
| A | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 | 0.675 | 0.75 | 0.80 | 0.027 | 0.030 | 0.032 |
| A1 | 0 | - | 0.05 | 0 | - | 0.002 | 0 | - | 0.05 | 0 | - | 0.002 |
| b | 0.23 | 0.30 | 0.38 | 0.009 | 0.012 | 0.015 | 0.23 | 0.30 | 0.38 | 0.009 | 0.012 | 0.015 |
| C | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 |
| D | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 |
| D1 | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 | 0.513 | 0.613 | 0.713 | 0.020 | 0.024 | 0.028 |
| D2 | 0.135 | 0.235 | 0.335 | 0.005 | 0.009 | 0.013 | | | | | | |
| E | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 | 1.98 | 2.05 | 2.15 | 0.078 | 0.081 | 0.085 |
| E1 | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 | 0.85 | 0.95 | 1.05 | 0.033 | 0.037 | 0.041 |
| E2 | 0.345 | 0.395 | 0.445 | 0.014 | 0.016 | 0.018 | | | | | | |
| E3 | 0.425 | 0.475 | 0.525 | 0.017 | 0.019 | 0.021 | | | | | | |
| e | 0.65 BSC | | | 0.026 BSC | | | 0.65 BSC | | | 0.026 BSC | | |
| K | 0.275 TYP | | | 0.011 TYP | | | 0.275 TYP | | | 0.011 TYP | | |
| K1 | 0.400 TYP | | | 0.016 TYP | | | 0.320 TYP | | | 0.013 TYP | | |
| K2 | 0.240 TYP | | | 0.009 TYP | | | 0.252 TYP | | | 0.010 TYP | | |
| K3 | 0.225 TYP | | | 0.009 TYP | | | | | | | | |
| K4 | 0.355 TYP | | | 0.014 TYP | | | | | | | | |
| L | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 | 0.175 | 0.275 | 0.375 | 0.007 | 0.011 | 0.015 |
| T | | | | | | | 0.05 | 0.10 | 0.15 | 0.002 | 0.004 | 0.006 |
| ECN: C-07431 – Rev. C, 06-Aug-07 | | | | | | | | | | | | |
| DWG: 5934 | | | | | | | | | | | | |

RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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